

IGBT Discretes

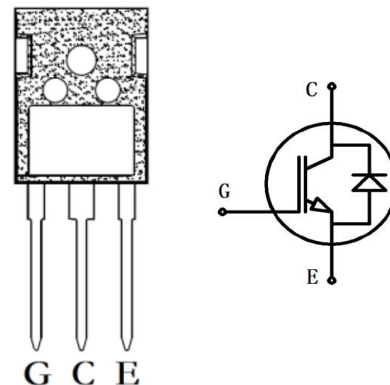
$$V_{CES} = 1350V, I_C = 30A, V_{CE(sat)} = 2.3V$$

Features:

- Trench and Field-stop technology
- Low collector to emitter saturation voltage
- Optimized for Fast Switching
- Easy parallel switching capability
- Short circuit withstands time - 10 μ s

Applications:

- Induction Heating
- Soft switching application



Absolute Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Value	Unit
V_{CES}	Collector to Emitter Voltage		1350	V
V_{GES}	Continuous Gate to Emitter Voltage		± 20	V
I_C	Continuous Collector Current	$T_C = 100^\circ\text{C}$	30	A
		$T_C = 25^\circ\text{C}$	60	A
I_{CM}	Pulse Collector Current	Pulse width limited by T_{jmax}	120	A
P_D	Maximum Power Dissipation (IGBT)	$T_C = 25^\circ\text{C}, T_J = 175^\circ\text{C}$	417	W
t_{sc}	Short Circuit Withstand Time	$V_{CC} = 600V, V_{GE} \leq 15V$	10	μs

Electrical Characteristics of IGBT ($T_J = 25^\circ\text{C}$)

Static characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C = 1mA, V_{CE} = V_{GE}, T_J = 25^\circ\text{C}$	4.9	5.9	6.9	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 30A, V_{GE} = 15V, T_J = 25^\circ\text{C}$	-	2.3	-	V
		$T_J = 125^\circ\text{C}$	-	2.8	-	
I_{CES}	Collector-Emitter Leakage Current	$V_{GE} = 0V, V_{CE} = V_{CES}, T_J = 25^\circ\text{C}$	-	-	1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE} = \pm 20V, V_{CE} = 0V, T_J = 25^\circ\text{C}$	-100	-	100	nA
C_{iss}	Input capacitance	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$	-	2485	-	pF
C_{oss}	Output capacitance		-	157	-	
C_{rss}	Reverse transfer capacitance		-	72	-	
R_{gint}	Internal gate resistor			1.3		Ω

Switching Characteristics

Switching Characteristics							
$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V, I_C=30A,$ $V_{GE}=\pm 15V, L=525\mu H,$ $R_g=4.8\Omega$	$T_J = 25^{\circ}C$		21		ns
			$T_J = 125^{\circ}C$		21		
t_r	Rise Time		$T_J = 25^{\circ}C$		24		ns
			$T_J = 125^{\circ}C$		25		
$t_{d(off)}$	Turn-off Delay Time		$T_J = 25^{\circ}C$		93		ns
			$T_J = 125^{\circ}C$		100		
t_f	Fall Time		$T_J = 25^{\circ}C$		286		ns
			$T_J = 125^{\circ}C$		360		
E_{on}	Turn-on Switching Loss		$T_J = 25^{\circ}C$		3.0		mJ
			$T_J = 125^{\circ}C$		3.3		
E_{off}	Turn-off Switching Loss	$T_J = 25^{\circ}C$		1.5		mJ	
		$T_J = 125^{\circ}C$		2.3			
$R_{\theta JC}$	Junction-To-Case (IGBT)				0.36		K/W

Electrical Characteristics of Diode ($T_J = 25^\circ C$)
Static characteristics

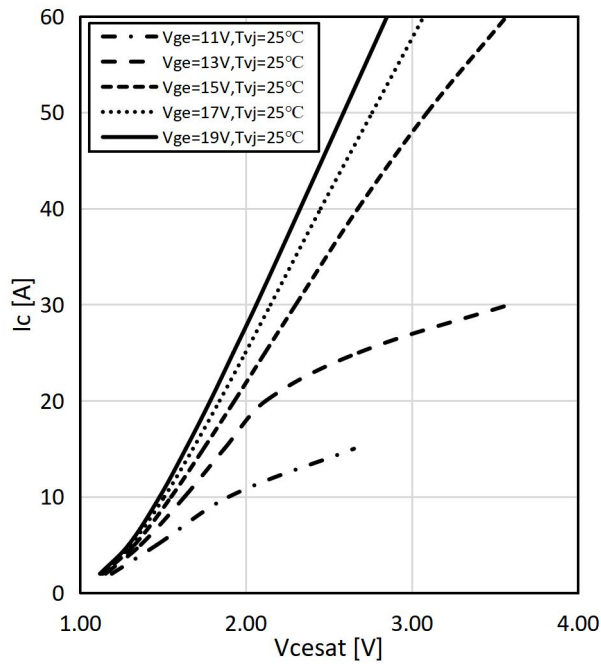
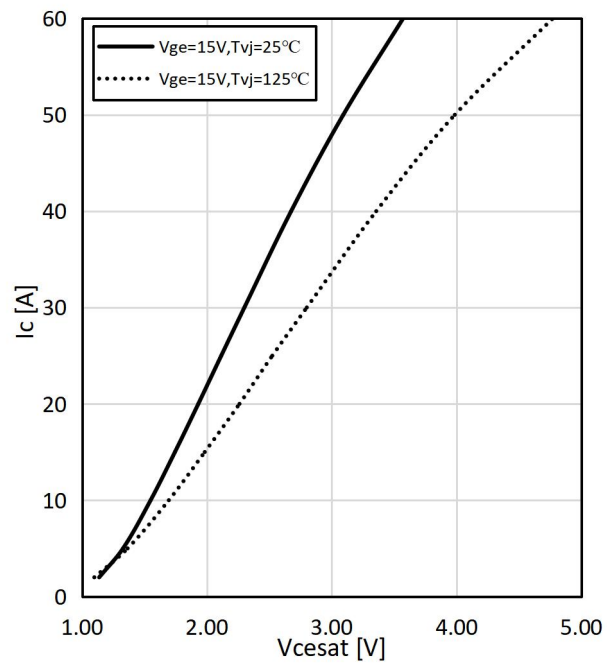
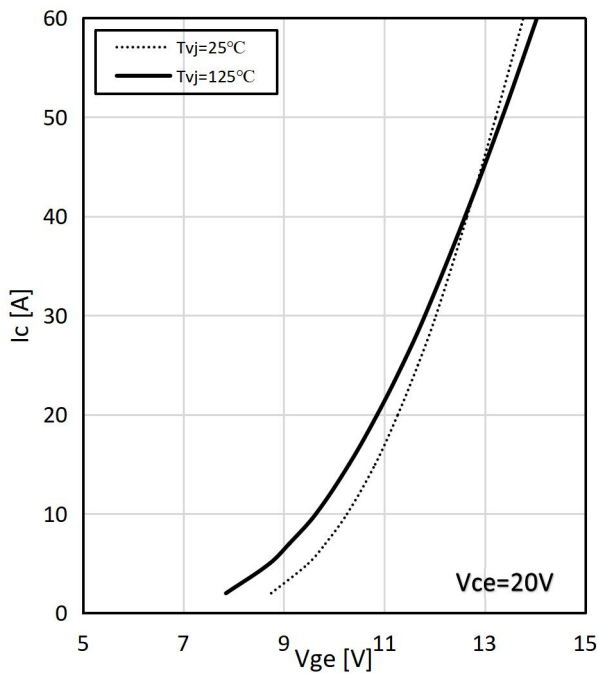
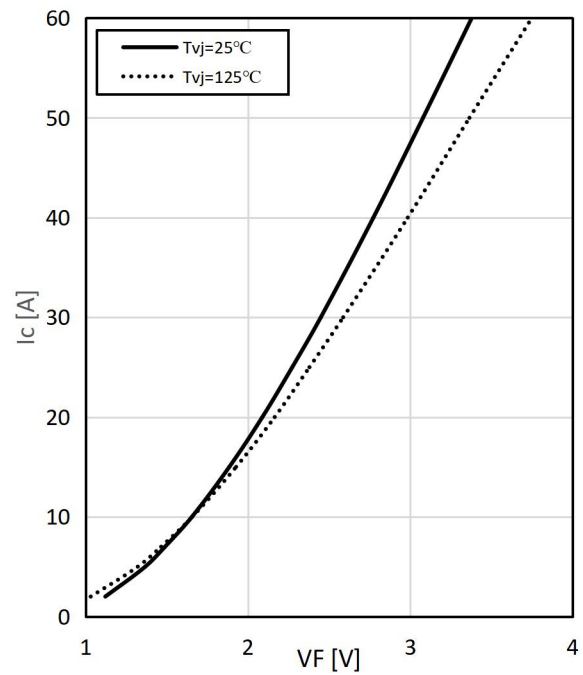
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{FM}	Forward Voltage	$I_F=30A, V_{GE}=0V$	$T_J = 25^\circ C$		2.4		V
			$T_J = 125^\circ C$		2.6		

Switching Characteristics

I _{rr}	Peak Reverse Recovery Current	I _F =30A, V _{CC} =600V, V _{GE} =-15V, L=525uH, R _g =4.8Ω	T _J = 25°C		54		A
			T _J = 125°C		68		
Q _{rr}	Reverse Recovery Charge		T _J = 25°C		4.5		μC
			T _J = 125°C		7.3		
E _{rec}	Reverse Recovery Energy		T _J = 25°C		1.9		mJ
			T _J = 125°C		3.3		
R _{θJC}	Junction-To-Case (Diode)				0.95		K/W

Module Characteristics

T_J	Junction Temperature	-40		+175	$^\circ C$
T_{JOP}	Operating Junction Temperature	-40		+175	$^\circ C$
T_{stg}	Storage Temperature	-55		+150	$^\circ C$


Fig.1 output characteristic IGBT Inverter (typical)

Fig.2 output characteristic IGBT Inverter (typical)

Fig.3 transfer characteristic IGBT Inverter (typical)

Fig.4 forward characteristic of Diode Inverter (typical)

$V_{CC}=600V$, $V_{CE}=\pm 15V$
 $R_G=4.8\Omega$

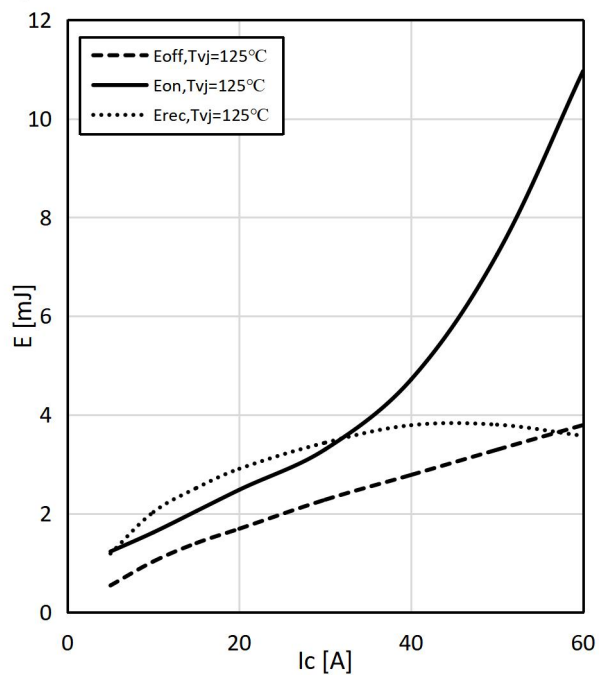


Fig.5 switching losses IGBT Inverter (typical)

$V_{CC}=600V$, $V_{CE}=\pm 15V$
 $I_C=30A$

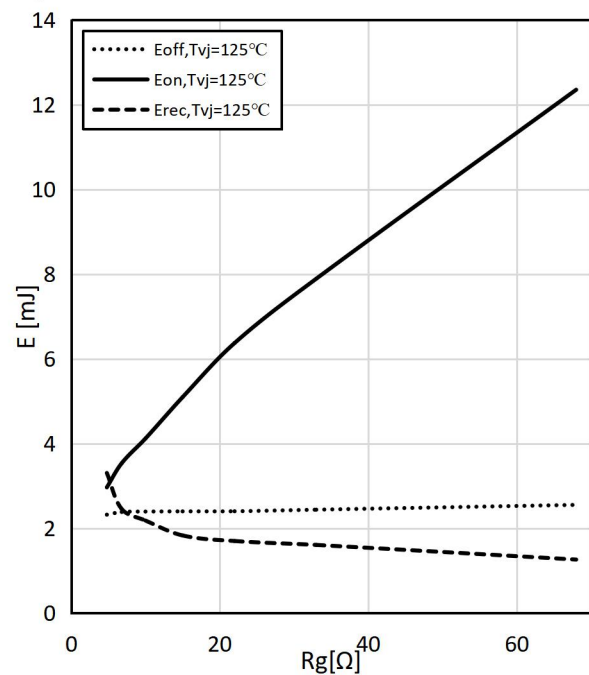


Fig.6 switching Losses vs. Gate Resistance (typical)

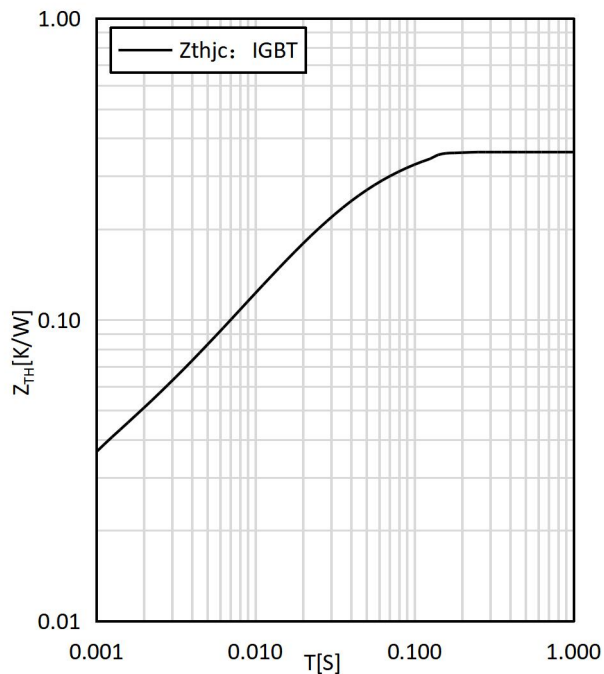


Fig.7 transient thermal impedance IGBT

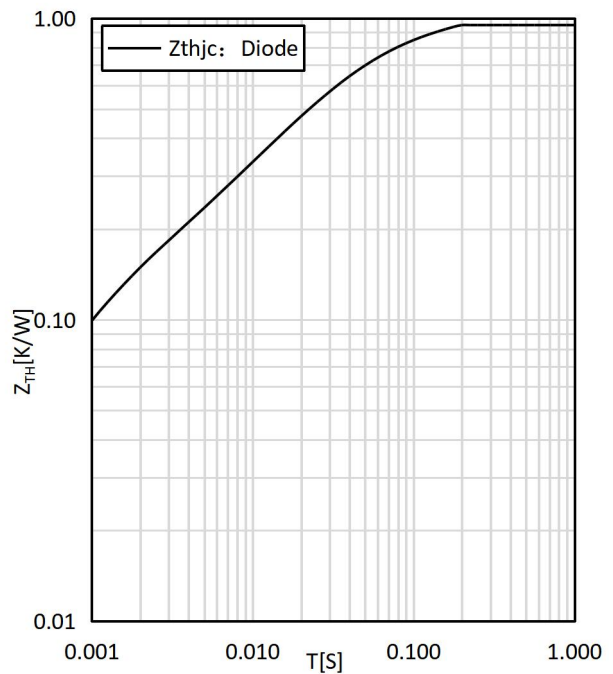


Fig.8 transient thermal impedance Diode

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